

Positive Thermal Coefficent Diodes

SMD1210P005~150 Series

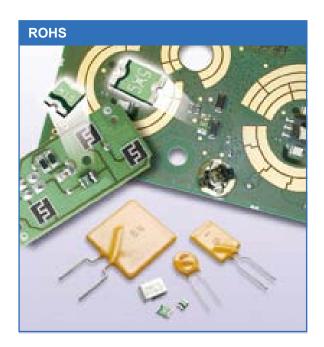
The SMD1210 Series PTC provides surface mount overcurrent protection for applications where space is at a premium and resettable protection is desired.

Features

- RoHS compliant, lead-free and halogen-free
- Fast response to fault currents
- Compact design saves board space
- Low resistance
- Low-profile
- · Compatible with high temperature solders

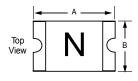
Applications

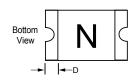
- USB peripherals
- Disk drives
- CD-ROMs
- Plug and play protection for motherboards and peripherals
- Mobile phones battery and port protection
- Disk drives
- PDAs / digital cameras
- Game console port protection



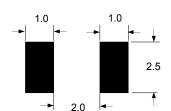
Dimension

MARKING CODE VARIES WITH AMPERAGE RATING (See Electrical CharacteristicTable) SHOWN IS 1.0AMP RATING









Model	А		В		С		D
	Min.	Max.	Min.	Max.	Min.	Max.	Min.
SMD1210P010TF	3.00	3.43	2.35	2.80	0.30	1.25	0.30
SMD1210P020TF	3.00	3.43	2.35	2.80	0.30	1.25	0.30
SMD1210P035TF	3.00	3.43	2.35	2.80	0.30	0.85	0.30
SMD1210P050TF	3.00	3.43	2.35	2.80	0.30	0.85	0.30
SMD1210P075TF	3.00	3.43	2.35	2.80	0.30	1.30	0.30
SMD1210P100TF	3.00	3.43	2.35	2.80	0.30	1.30	0.30
SMD1210P110TF	3.00	3.43	2.35	2.80	0.30	1.30	0.30
SMD1210P125TF	3.00	3.43	2.35	2.80	0.40	1.50	0.30

Electriacl Characteristics

Type Number	I hold	I trip	Vmax	I max	P _d max.	Maximum Time To Trip		Resistance	
	(A)	(A)	V(dc)	(A)	(W)	Current (A)	Time (Sec.)	Rmin (Ω)	R1max (Ω)
SMD1210P005TF	0.05	0.15	30	100	0.6	0.25	1.50	2.80	50.00
SMD1210P010TF	0.10	0.30	40	100	0.6	0.50	0.60	0.80	15.00
SMD1210P020TF	0.20	0.40	30	100	0.6	8.00	0.02	0.40	5.00
SMD1210P035TF	0.35	0.75	6	100	0.6	8.00	0.20	0.20	1.30
SMD1210P050TF	0.50	1.00	13.2	100	0.6	8.00	0.10	0.18	0.90
SMD1210P075TF	0.75	1.50	6	100	0.6	8.00	0.10	0.07	0.40
SMD1210P110TF	1.10	2.20	6	100	0.6	8.00	0.30	0.05	0.21
SMD1210P150TF	1.50	3.00	6	100	0.6	8.00	0.50	0.30	0.11

I_{hold} = Hold current: maximum current device will pass without tripping in 23°C still air.

I_{trip} = Trip current: minimum current at which the device will trip in 23°C still air.

 V_{max} = Maximum voltage device can withstand without damage at rated current (I_{max})

 I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max})

Pd = Power dissipated from device when in the tripped state at 23°C still air.

R_{min} = Minimum resistance of device in initial (un-soldered) state.

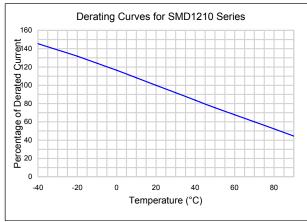
R_{typ} = Typical resistance of device in initial (un-soldered) state.

R_{1max} = Maximum resistance of device at 23°C measured one hour after tripping or reflow soldering of 260°C for 20 sec.

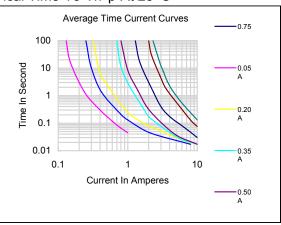
Thermal Derating Chart-IH(A)

Model	Maximum ambient operating temperature (Tmao) vs. hold current (Ihold)									
	-40°C	-20°C	0°C	23°C	40°C	50°C	60°C	70°C	85°C	
SMD1210P010TF	0.08	0.07	0.06	0.05	0.04	0.04	0.03	0.03	0.02	
SMD1210P020TF	0.16	0.14	0.12	0.10	0.08	0.07	0.06	0.05	0.03	
SMD1210P035TF	0.29	0.26	0.22	0.20	0.16	0.14	0.13	0.11	0.08	
SMD1210P050TF	0.47	0.45	0.40	0.35	0.33	0.28	0.24	0.21	0.18	
SMD1210P075TF	0.76	0.67	0.58	0.50	0.43	0.40	0.36	0.32	0.28	
SMD1210P100TF	1.00	0.97	0.86	0.75	0.64	0.59	0.54	0.48	0.40	
SMD1210P110TF	1.69	1.48	1.29	1.10	0.88	0.76	0.65	0.57	0.43	
SMD1210P125TF	2.13	1.92	1.71	1.50	1.26	1.14	1.01	0.89	0.71	

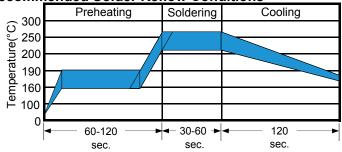




Typical Time-To-Tri p At 25°C



Recommended Solder Reflow Conditions



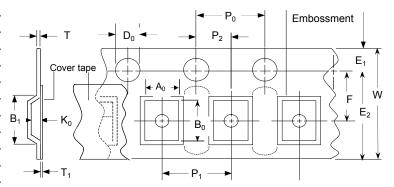
- Recommended reflow methods: IR, vapor phase oven, hot air oven.
- Devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness is 0.25 mm (0.010 inch).
- · Devices can be cleaned using standard method and solvents.

Note: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

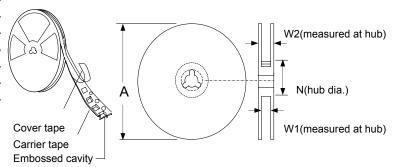
Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-2
W	8.0 ± 0.20
P ₀	4.0 ± 0.10
P ₁	4.0 ± 0.10
P ₂	2.0 ± 0.10
A_0	2.82 ± 0.10
B ₀	3.52± 0.10
B₁max.	4.35
D_0	1.5 + 0.1, -0.0
F	7.5 ± 0.05
E ₁	1.75 ± 0.10
E ₂ min.	6.25
Tmax.	0.6
T₁max.	0.1
K ₀	0.90 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	50
W ₁	8.4 + 1.5, -0.0
W ₂ max.	22.4
	·

EIA Tape Component Dimentions



EIA Reel Dimentions



Storage And Handling

- · Storage conditions: 40°C max, 70% R.H.
- · Devices may not meet specified performance if storage conditions are exceeded.

Order Information	Packaging					
SMD1210	050	Tape & Reel Quantity				
Product name	Hold	050,075	4,000 pcs/reel			
Size 3225 mm / 1210 mils	Current	The others	4,500 pcs/reel			
SMD: surface mount device	0.50A					

Tape & reel packaging per EIA481-1

Leiditech Electronics are trademarks.

Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Leiditech Electronics reserves the right to change or update, without notice, any information contained in this publication; to change, without notice, the design, construction, processing, or specification of any product; and to discontinue or limit production or distribution of any product. This publication supersedes and replaces all information previously supplied. Without expressed or written consent by an officer of Leiditech Electronics, Leiditech Electronics does not authorize the use of any of its products as components in nuclear facility applications, aerospace, or in critical life support devices or systems. Leiditech Electronics expressly disclaims all implied warranties regarding the information contained herein, including, but not limited to, any implied warranties of merchantability or fitness for a particular purpose. Leiditech Electronics' only obligations are those in the Leiditech Electronics Standard Terms and Conditions of Sale and in no case will Leiditech Electronics be liable for any incidental, indirect, or consequential damages.

SHANGHAI LEIDITECH ELECTRONICS CO.,LTD

Tel: +86- 021 50828806 Fax: +86- 021 50477059-8008 Email: sale1@leiditech.com